

**TENTATIVE**
**Features and Applications**

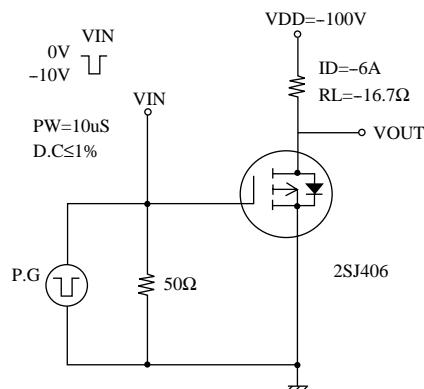
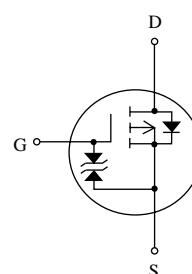
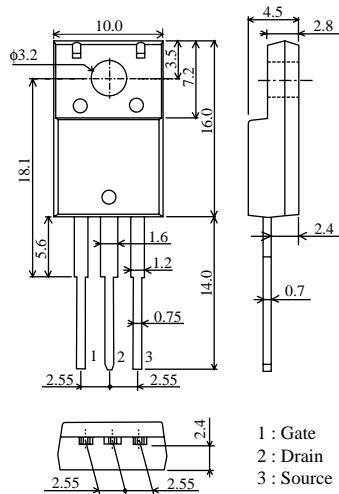
- Low ON-state resistance.
- Very high-speed switching.
- Low-voltage drive.
- Micaless package facilitating easy mounting.

**Absolute Maximum Ratings / Ta=25°C**

			unit	
Drain to Source Voltage	VDSS	-200	V	
Gate to Source Voltage	VGSS	$\pm 20$	V	
Drain Current (D.C.)	ID	-12	A	
Drain Current (Pulse)	IDP	PW≤10μS, dutycycle≤1%	A	
Allowable power Dissipation	PD	Tc=25°C	40	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

**Electrical Characteristics / Ta=25°C**

			min	typ	max	unit
Drain to Source Breakdown Voltage	V(BR)DSS	ID=-1mA , VGS=0	-200			V
Gate to Source Breakdown Voltage	V(BR)GSS	ID=±100μA , VGS=0	$\pm 20$			V
Zero Gate Voltage Drain Current	IDSS	VDS=-200V , VGS=0			-100	μA
Gate to Source Leakage Current	IGSS	VGS=±16V , VDS=0			±10	μA
Cutoff Voltage	VGS(OFF)	VDS=-10V , ID=-1mA	-1.5		-2.5	V
Forward Transfer Admittance	yfs	VDS=-10V , ID=-6A	6.3	10.5		S
Static Drain to Source on State Resistance	RDS(On)1	ID=-5A , VGS=-4V	170	230		mΩ
Input Capacitance	Ciss	VDS=-20V , f=1MHz	2400			pF
Output Capacitance	Coss	VDS=-20V , f=1MHz	540			pF
Reverse Transfer Capacitance	Crss	VDS=-20V , f=1MHz	260			pF
Turn-ON Delay Time	td(On)		40			ns
Rise Time	tr	See Specified Test	120			ns
Turn-off Delay Time	td(Off)	Circuit .	720			ns
Fall Time	tf		310			ns
Diode Forward Voltage	VSD	IS =-1.0A , VGS = 0	-1.0	-1.5		V

**Switching Time Test Circuit**

**Electrical Connection**

**Case Outline TO-220 (unit:mm)**


Specifications and information herein are subject to change without notice.

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